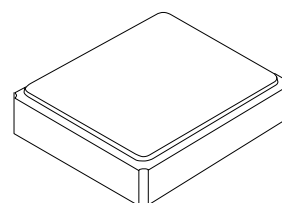


XTL2077G-1

**32.000000 MHz
Crystal Unit**



SM2520-4

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- AEC-Q200 compliance
- Moisture Sensitivity Level (MSL) : Level-1

Description and Applications:

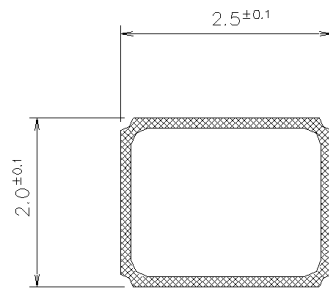
Surface mount 2.5 mm x2.0 mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

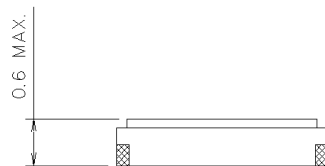
XTL2077G-1	Specification
Nominal Frequency	32.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +125°C
Operating Temperature Range	-40°C to +85°C
Frequency Stability over Operating Temperature Range	+/-20 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/-10 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	40 Ω max
Nominal Drive Level	10uW typical and 200uW max
Shunt Capacitance (Co)	3.0 pF max
Load Capacitance (CL)	8 pF
Aging	+/-2ppm/year
Insulation Resistance	500 M Ω min./DC 100V
Marking	Laser Marking
Unit Weight	9.5 +/-0.5mg

Mechanical Dimensions (mm):

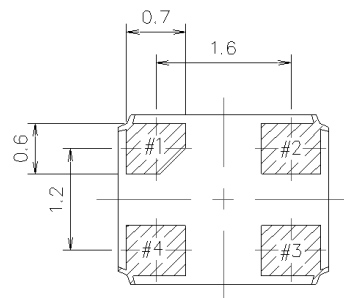
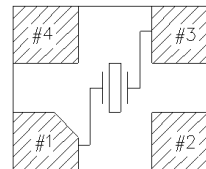
Base



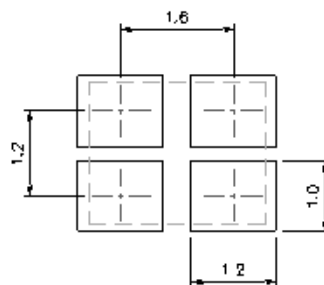
	Pin Connection
#1 pin	IN/OUT
#2 pin	GND
#3 pin	IN/OUT
#4 pin	GND



Internal Connections
(Top View)



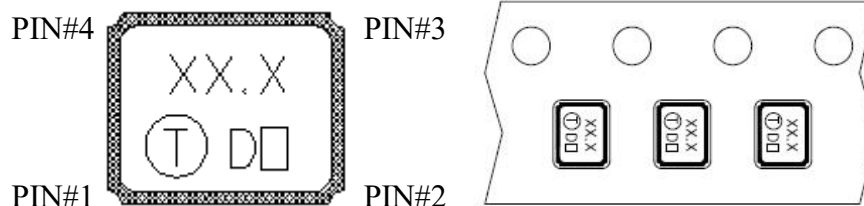
Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (32.0)

Line 2: Date Code + Product Code (☐ Internal tracking code, could be a~z and A~Z, 1 or 2 letters, underline or no underline)



The inner vision of PIN#1, PIN#4 side is XTAL blank mounting pad.

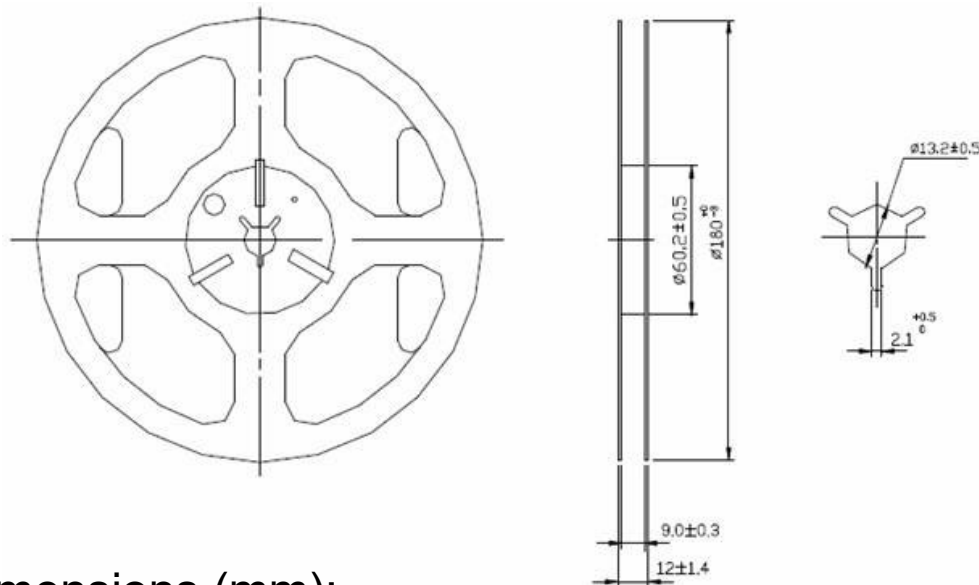
Date Code Table

Date Code Table												
WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
A	B	C	D	E	F	G	H	I	J	K	L	M
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	O	P	Q	R	S	T	U	V	W	X	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
a	b	c	d	e	f	g	h	i	j	k	l	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	o	p	q	r	s	t	u	v	w	x	y	z

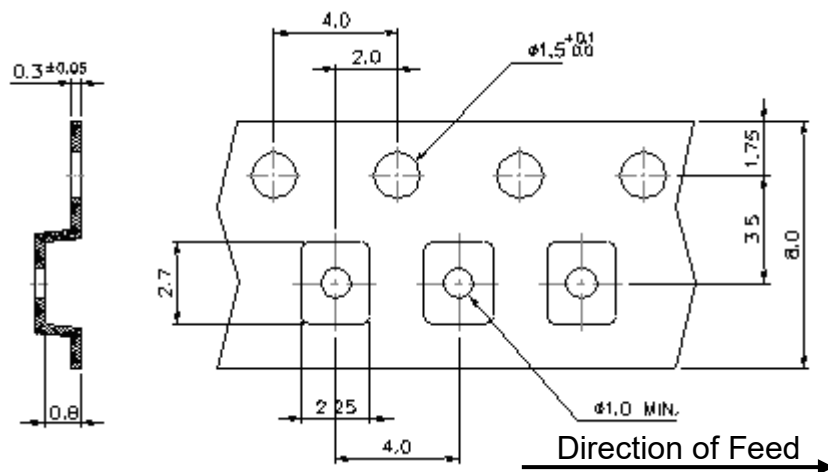
Product Code Table: (Under line With Even Year and Odd Year for Nothing)

Year						Product Code
2021	2023	2025	2027	2029	2031	<input type="checkbox"/>
2022	2024	2026	2028	2030	2032	<input type="checkbox"/>

Reel Dimensions (mm):



Tape Dimensions (mm):

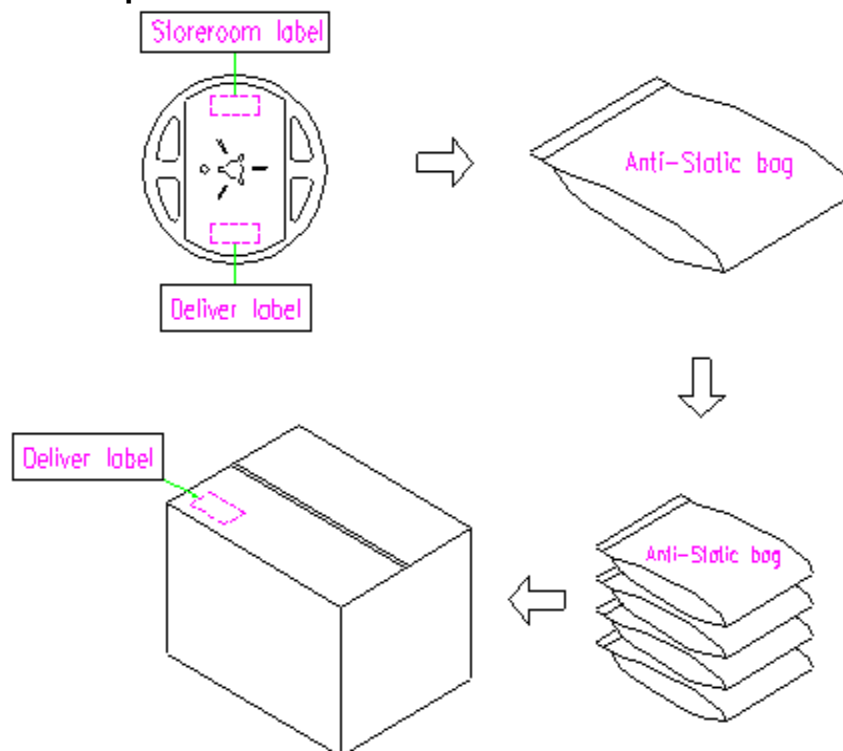


[NOTE]:

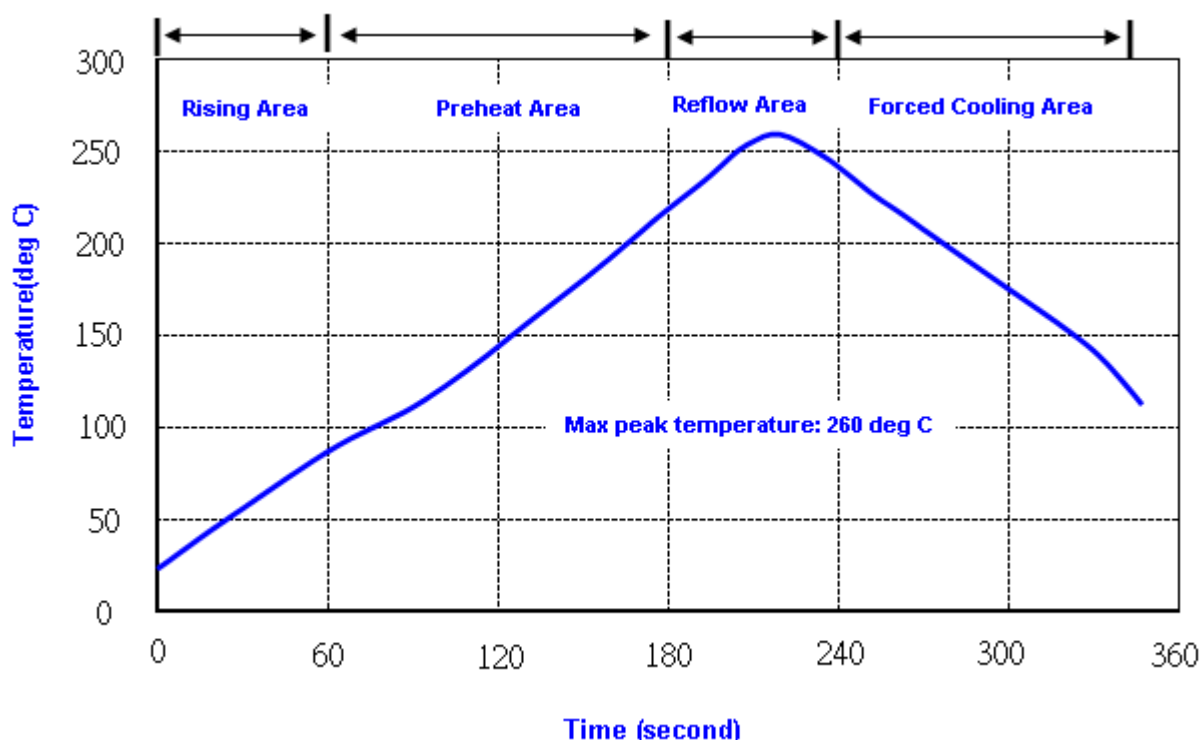
1. Unless otherwise specified tolerance on dimension ± 0.1 mm.
2. Material: conductive polystyrene with color black.
3. 10 pitch cumulative tolerance ± 0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1. Max peak temperature: 260 \pm 5 deg C; Time: 10 \pm 2 sec

2. Temperature: 217 \pm 5 deg C; Time: 90~100 sec

Reliability Specifications (AEC-Q200)

Test name	Test process / method	Reference standard
Mechanical characteristics		
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)
Vibration	Total peak amplitude : 1.5mm Vibration frequency : 10 to 2000 Hz Sweep period : 20 minute Vibration directions : 3 mutually perpendicular	MIL-STD 202G method 204
Mechanical Shock	directions : 3 impacts per axis Acceleration : 6000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213
Solderability	Solder Temperature:265±5°C Duration time: 5±0.5 seconds.	J-STD-002
Environmental characteristics		
Thermal Shock	Heat cycle conditions -55 °C (30min) ↔ 125 °C (30min) * cycle time : 1000 times	MIL-STD 883G method 1010.8
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 1000 hours	MIL-STD 202G method 103
Dry heat (Aging test)	Temperature : 125 ± 2 °C Duration : 1000 hours	MIL-STD 202G method 108A
Cold resistance (Low Temp Storage)	Temperature : -40 ± 3 °C Duration : 1000 hours	IEC 60068-2-1



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.